Positional Memory of Thermoreversible N-isopropylacrylamide Based Polymer Aggregates on Mica

<u>Avishay Pelah</u>¹, Elizabeth A. Jares-Erijman², Silvio J. Ludueña³, Igal Szleifer⁴, Lía I. Pietrasanta³, and Thomas M. Jovin¹

¹Department of Molecular Biology, Max Planck Institute for Biophysical Chemistry, D-37070 Göttingen, Germany; ²Departamento de Química Orgánica and ³Centro de Microscopías Avanzadas, Facultad de Ciencias Exactas y Naturales, Universidad de Buenos Aires, C1428EHA Buenos Aires, Argentina; ⁴Department of Chemistry, Purdue University, West Lafayette, Indiana 47907, USA.

Stimuli-responsive polymers are used extensively due to the controlled manner in which one can reversibly alter their physical characteristics. One of the best studied materials is the temperature-sensitive Poly (N-isopropylacrylamide) (PNIPAM), which reversibly phase separates above its lower critical solution temperature (LCST) of ~32° C ¹⁻⁴. Here we demonstrate an intriguing and novel property of a PNIPAM based polymer. With a temperature controlled atomic force microscope, we show that polymer aggregates formed on mica above the polymer's LCST and dispersed below it, display positional "memory". That is, the nano-aggregates appear at the same positions during successive cooling/heating cycles preserving a given pattern across the entire image (Fig. 1). This phenomenon can be rationalized from theoretical considerations and has practical implications, i.e. in the development of new nano-micro scale devices.

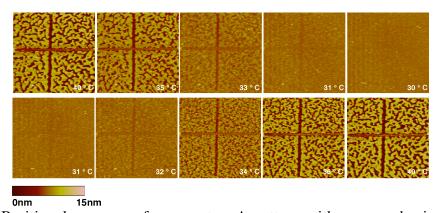


Figure 1. Positional memory of aggregates. A pattern with nano and micro features dissolves upon cooling and reappears upon heating [images are 10×10 microns].

References

- 1. Heskins, M. & Guillet, J. E. J. Macromol. Sci., Chem. 2, 1441-1455 (1968).
- 2. Chan, K., Pelton, R. & Zhang, J. *Langmuir* **15**, 4018-4020 (1999).
- 3. Kulkarni, S., Schilli, C., Müller, A. H. E., Hoffman, A. S. & Stayton, P. S. *Bioconj. Chem.* **15**, 747-753 (2004).
- 4. Lee, L. T., Leite, C. A. P. & Galembeck, F. *Langmuir* **20**, 4430-4435 (2004).